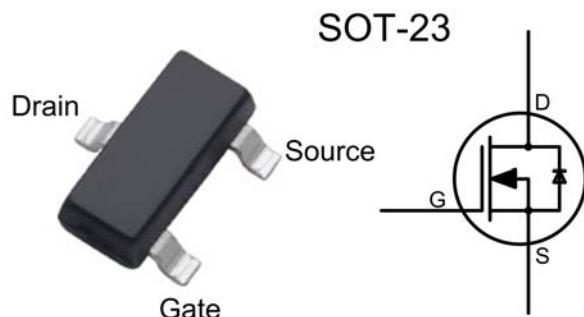


Depletion-Mode Power MOSFET

General Features

- ESD improved Capability
- Depletion Mode (Normally On)
- Proprietary Advanced Planar Technology
- Rugged Polysilicon Gate Cell Structure
- Fast Switching Speed
- RoHS Compliant
- Halogen-free available

BV_{DSX}	$R_{DS(ON)}(\text{Max.})$	$I_{DSS,\min}$
600V	120 Ω	100mA



Applications

- Normally-on Switches
- SMPS Start-up Circuit
- Linear Amplifier
- Converters
- Constant Current Source
- Telecom

Ordering Information

Part Number	Package	Marking	Remark
HM1060E	SOT-23	61***	Halogen Free

Absolute Maximum Ratings

$T_A=25^\circ\text{C}$ unless otherwise specified

Symbol	Parameter	HM1060E	Unit
V_{DSX}	Drain-to-Source Voltage ^[1]	600	V
V_{DGX}	Drain-to-Gate Voltage ^[1]	600	V
I_D	Continuous Drain Current	0.1	A
I_{DM}	Pulsed Drain Current ^[2]	0.4	
P_D	Power Dissipation	0.50	W
V_{GS}	Gate-to-Source Voltage	± 20	V
T_L	Soldering Temperature Distance of 1.6mm from case for 10 seconds	300	$^\circ\text{C}$
T_J and T_{STG}	Operating and Storage Temperature Range	-55 to 150	

Caution: Stresses greater than those listed in the "Absolute Maximum Ratings" may cause permanent damage to the device.

Thermal Characteristics

Symbol	Parameter	HM1060E	Unit
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	250	K/W

Electrical Characteristics

OFF Characteristics

T_A = 25°C unless otherwise specified

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions
BV _{DSX}	Drain-to-Source Breakdown Voltage	600	--	--	V	V _{GS} =-5V, I _D =250μA
I _{D(OFF)}	Drain-to-Source Leakage Current	--	--	0.1	μA	V _{DS} =600V, V _{GS} =-5V
		--	--	10	μA	V _{DS} =600V, V _{GS} =-5V T _J =125°C
I _{GSS}	Gate-to-Source Leakage Current	--	--	20	uA	V _{GS} =+20V, V _{DS} =0V
		--	--	20		V _{GS} =-20V, V _{DS} =0V

ON Characteristics

T_A = 25°C unless otherwise specified

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions
I _{DSS}	Saturated Drain-to-Source Current	100	--	130	mA	V _{GS} =0V, V _{DS} =25V
R _{DS(ON)}	Static Drain-to-Source On-Resistance	--	110	120	Ω	V _{GS} =0V, I _D =50mA ^[3]
V _{GS(OFF)}	Gate-to-Source Cut-off Voltage	-3.0	--	-1.8	V	V _{DS} =3V, I _D =8μA
g _{fs}	Forward Transconductance	--	--	--	mS	V _{DS} =10V, I _D =5mA

Dynamic Characteristics

Essentially independent of operating temperature

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions
C _{ISS}	Input Capacitance	--	--	--	pF	V _{GS} =-5V V _{DS} =25V f=1.0MHz
C _{OSS}	Output Capacitance	--	--	--		
C _{RSS}	Reverse Transfer Capacitance	--	--	--		
Q _G	Total Gate Charge	--	--	--	nC	V _{GS} =-5V~5V V _{DS} =300V, I _D =7mA
Q _{GS}	Gate-to-Source Charge	--	--	--		
Q _{GD}	Gate-to-Drain (Miller) Charge	--	--	--		

Resistive Switching Characteristics

Essentially independent of operating temperature

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions
t _{d(ON)}	Turn-on Delay Time	--	--	--	ns	V _{GS} = -5V~5V V _{DD} = 300V, I _D =7mA R _G = 20Ω
t _{rise}	Rise Time	--	--	--		
t _{d(OFF)}	Turn-off Delay Time	--	--	--		
t _{fall}	Fall Time	--	--	--		

Source-Drain Diode Characteristics

T_A=25°C unless otherwise specified

Symbol	Parameter	Min	Typ.	Max.	Units	Test Conditions
V _{SD}	Diode Forward Voltage	--	--	1.2	V	I _{SD} =100 mA, V _{GS} = -10 V

NOTE:

[1] T_J=+25°C to +150°C

[2] Repetitive rating, pulse width limited by maximum junction temperature.

[3] Pulse width≤380μs;duty cycle≤2%.

Package Dimensions

SOT-23

